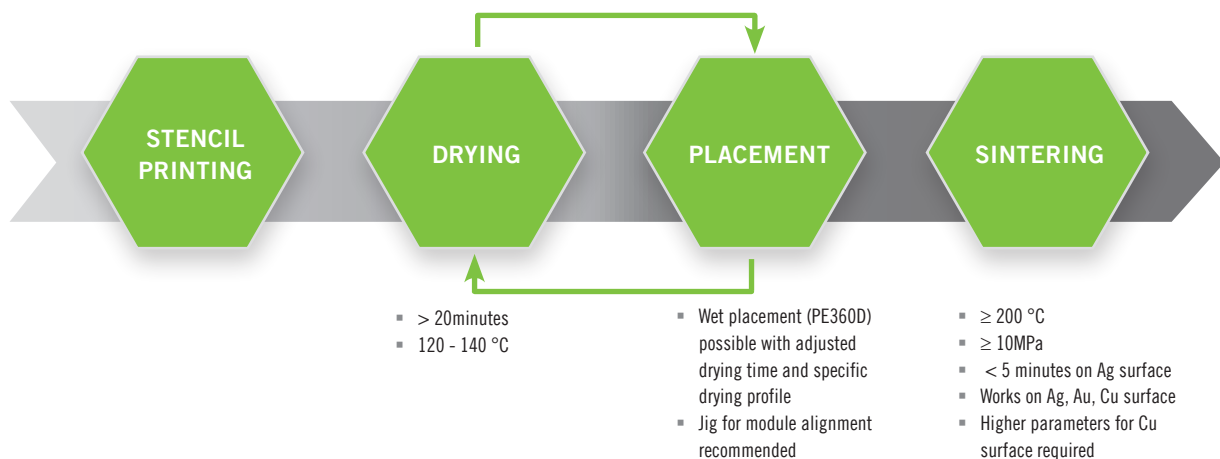


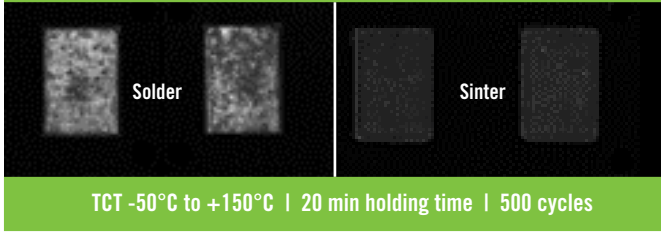


## mAgic® PE360 Pressure Silver Sinter Paste for Module Attach Applications

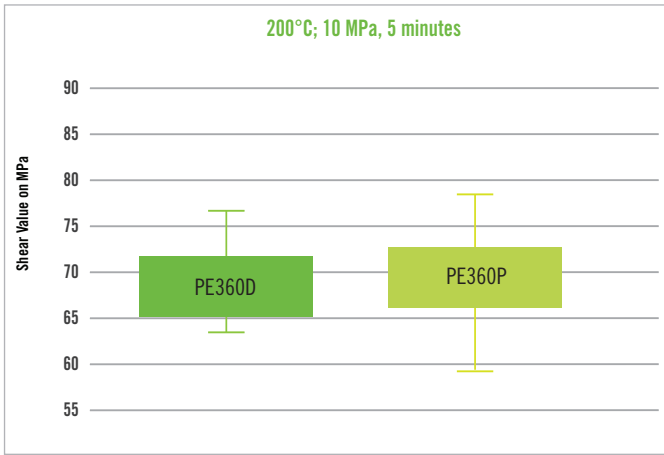
PE360 is a pressure sinter paste developed for module attach applications. It comes in two different versions. PE360P is suitable for the stencil printing and dry module placement and PE360D works for dispensing and wet-/dry-placement process. Both offer excellent thermal performance, achieved with fast process times and for the application optimized workability.



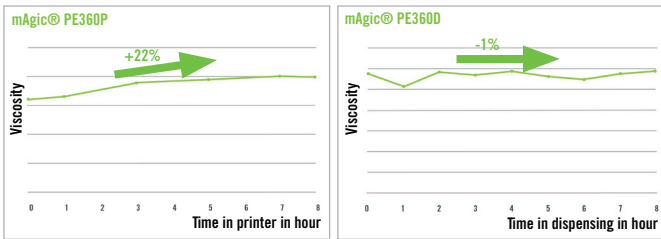
### Superior Reliability under Harsh Conditions



### Shear Value on ~220mm<sup>2</sup>



### Excellent Long Term Paste Workability for Printing and Dispensing Application



- Excellent printing performance overtime
- Consistent paste deposit volume for high production efficiency
- Stable rheology for long stencil life

Product Properties	PE360P	PE360D
Alloy	Silver	
Metal Content	87% +/- 1%	
Fillers	0%	
Particle Size	≤ 25 μm	
Sinter Temperature	≥ 200°C	
Halogen Content	Halogen Zero	
Compatible Surfaces	Ag, Cu	
Sinter Atmosphere	Air/N <sub>2</sub>	
Application Process	PE360P	PE360D
Printing	Yes	No
Dispensing	No	Yes
Features and Benefits	PE360P	PE360D
Work Life	8 hours	
Shelf Life	6 months	3 months
Residue Cleaning	Not required	
Storage Condition	-18 to -22°C	
Shipping Condition	2 to 10°C	

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